

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



In re application of:

CHAD A. COBBLEY
TONGBI JIANG
ED A. SCHROCK

Serial No. 08/916,629

Art Unit: 1733

Filing Date: 08/22/1997

Examiner: Aftergut, J.H.

For: SEMICONDUCTOR DIE ATTACHMENT
METHOD AND APPARATUS

Attorney Docket No. 97-0098

Confirmation No. 3496

Customer No. 22823

**AMENDMENT SUBMITTED WITH REQUEST FOR CONTINUED
EXAMINATION (RCE) UNDER 37 CFR 1.114**

April 6, 2007

Mail Stop RCE
Commissioner For Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

This Amendment accompanies a Request For Continued Examination, and follows the Decision On Appeal decided February 8, 2007.

The Request For Continued Examination and Amendment are being filed within two months of the Decision On Appeal. In addition, neither a Notice of Appeal to the Federal Circuit, or a Civil Action in Federal District Court has been filed. The Request For Continued Examination and Amendment thus comply with the provisions of MPEP 706.07(h).

Please amend the application as follows.

04/10/2007 HDESTA1 00000048 071857 08916629

02 FC:1201 600.00 DA
03 FC:1202 350.00 DA